## **Photopatterned Noble Metal Functional Surfaces Via Galvanic Replacement Reaction**





**Graduate School** & International Education Microelectronics-Photonics

**on Cu<sub>2</sub>O Thin Films** Student: Blake D. Trickey Faculty Advisor: Dr. Robert Coridan(CHEM) Undergrad. School / Major: SE Missouri State Univ. / Physics **Conventional Materials & Processes** Nanoscience & Engineering

## **Background/Relevance** Approach Construct Michelson Interferometer. • Cuprous oxide is a semiconductor with a wide use of photovoltaic and photoelectrochemical applications due to Michelson Interferometer deemed incorrect, too • small band gap, also strong for direct photoelectrodeposition. unstable. Traditional photolithography used in many applications, such as ٠ Construct 1mm pinhole, 405 nm laser, 3 cm - Cu<sub>2</sub>O photomask structured electrocatalysts for energy conversion and away, then pattern from circular diffraction. photoelectrodeposited microelectronics, but inefficient and time sensitive. Analyze patterning size of local changed • Innovation chemistry of Cu nanoinclusions in Cu<sub>2</sub>O at solution temperature of 60°C. A more direct way to photopattern structures being more time Use Galvanic replacement reaction to sacrifice and cost effective. Cu<sub>2</sub>O leaving behind Au. Determine resolution limit of patterning. -Pinhole Setup Conclusions **Key Results** Determined spacing around ~20 µm Patterning too intense in center from laser, too much Cu. Galvanic replacement reaction washed away most of the Effective small patterning method confirmed by direct • pattern, leaving behind trace amounts of Au. photoelectrodeposition. Many of the patterns created exhibited a "blurred" pattern, as Future work desires to use a less intense laser to attempt to ٠ only 7/26 provided "clean" results. develop more Au. Future work dedicated to constructing a Lloyd's mirror setup to ٠ pattern lines of patterned structures rather than the circular patterns. Acknowledgements to Dr. Robert Coridan and James Lowe for their support and assistance in the success of our project. Research Funded

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**Direct Photoelectrodeposition** 

GRR after 300 s

## **Research Areas**

- Microelectronics
- Conventional Materials & Processes
- Physical & Chemical Sensors
- Modeling and Simulation
- Photonics
- Biological Materials & Processes
- Nanoscience & Engineering
- Biological Sensors
- Commercialization